

Molding Type Module

1200V/40A 2 in one-package

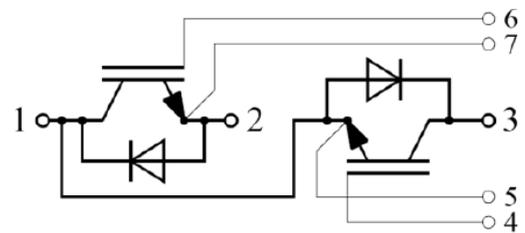
General Description

IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as electronic welders.



Features

- Low $V_{CE(sat)}$ trench IGBT technology
- 10 μ s short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175 $^{\circ}$ C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology



Equivalent Circuit Schematic

Typical Applications

- Switching mode power supplies
- Electronic welders

Absolute Maximum Ratings $T_c=25^{\circ}$ C unless otherwise noted

| Symbol | Description | | Units |
|-------------------|---|--------------------------|--------------|
| V _{CE} S | Collector-Emitter Voltage | 1200 | V |
| V _{GE} S | Gate-Emitter Voltage | ± 20 | V |
| I _C | Collector Current @ $T_c=25^{\circ}$ C T_{vj} max = 175 $^{\circ}$ C | 40 | A |
| I _{CM} | Pulsed Collector Current $t_p=1$ ms | 80 | A |
| I _F | Diode Continuous Forward Current | 40 | A |
| I _{FM} | Diode Maximum Forward Current $t_p=1$ ms | 80 | A |
| P _{tot} | Maximum Power Dissipation @ $T_j=175^{\circ}$ C | 205 | W |
| T _{jmax} | Maximum Junction Temperature | 175 | $^{\circ}$ C |
| T _{STG} | Storage Temperature Range | -40 to +125 | $^{\circ}$ C |
| V _{ISO} | Isolation Voltage RMS, f=50Hz, t=1min | 2500 | V |
| Mounting Torque | Power Terminal Screw:M5 Mounting Screw:M6 | 2.5 to 5.0 3.0 to 5.0 | N.m |

Electrical Characteristics of IGBT $T_C=25^{\circ}\text{C}$ unless otherwise noted

Off Characteristics

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|---------------|-------------------------------------|---|------|------|------|-------|
| $V_{(BR)CES}$ | Collector-Emitter Breakdown Voltage | $T_j=25^{\circ}\text{C}$ | 1200 | | | V |
| I_{CES} | Collector Cut-Off Current | $V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$ | | | 1.5 | mA |
| I_{GES} | Gate-Emitter Leakage Current | $V_{GE}=\pm 20, V_{CE}=0\text{V}, T_j=25^{\circ}\text{C}$ | | | 100 | nA |

On Characteristics

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|---------------|---|--|------|------|------|-------|
| $V_{GE(th)}$ | Gate-Emitter Threshold Voltage | $I_C=2.4\text{mA}, V_{CE}=V_{GE}, T_j=25^{\circ}\text{C}$ | 5.0 | - | 6.5 | V |
| $V_{CE(sat)}$ | Collector to Emitter Saturation Voltage | $I_C=40\text{A}, V_{GE}=15\text{V}, T_j=25^{\circ}\text{C}$ | 1.6 | - | 3.0 | V |
| | | $I_C=40\text{A}, V_{GE}=15\text{V}, T_j=125^{\circ}\text{C}$ | | 2.0 | | |

Switching Characteristics

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units | |
|------------|-------------------------|--|------|------|------|-------|----|
| $t_d(on)$ | Turn-On Delay Time | $V_{CE}=600\text{V}, I_C=40\text{A}, R_G=10\Omega, V_{GE}=\pm 15\text{V}, T_j=25^{\circ}\text{C}$ | | 65 | | ns | |
| t_r | Rise Time | | | 95 | | ns | |
| $t_d(off)$ | Turn-Off Delay Time | | | 450 | | ns | |
| t_f | Fall Time | | | 35 | | ns | |
| E_{on} | Turn-On Switching Loss | | | | 3.1 | | mJ |
| E_{off} | Turn-Off Switching Loss | | | | 2.3 | | mJ |
| $t_d(on)$ | Turn-On Delay Time | $V_{CE}=600\text{V}, I_C=40\text{A}, R_G=10\Omega, V_{GE}=\pm 15\text{V}, T_j=125^{\circ}\text{C}$ | | 60 | | ns | |
| t_r | Rise Time | | | 80 | | ns | |
| $t_d(off)$ | Turn-Off Delay Time | | | 500 | | ns | |
| t_f | Fall Time | | | 50 | | ns | |
| E_{on} | Turn-On Switching Loss | | | | 3.6 | | mJ |
| E_{off} | Turn-Off Switching Loss | | | | 2.6 | | mJ |

| | | | | | | |
|----------------------|--|--|--|------|----|----|
| Cies | Input Capacitance | V _{CE} =25V, f=1MHz, V _{GE} =0V | | 4.28 | | nF |
| C _{res} | Reverse Transfer Capacitance | | | 0.13 | | nF |
| Q _G | Gate Charge | V _{GE} =-15V ...+15V | | 262 | | nC |
| R _{Gint} | Internal Gate Resistance | | | 2.35 | | Ω |
| LCE | Stray Inductance | | | | 30 | nH |
| R _{CC'+EE'} | Module Lead Resistance, Terminal To Chip | | | 0.75 | | mΩ |

Electrical Characteristics of Diode T_c=25°C unless otherwise noted

| Symbol | Parameter | Test Conditions | | Min. | Typ. | Max. | Units |
|------------------|-------------------------------|---|----------------------|------|------|------|-------|
| V _F | Diode Forward Voltage | I _F =40A | T _j =25°C | 2.5 | - | 7.0 | V |
| Q _r | Recovered Charge | I _F =40A, V _R =600V, | T _j =25°C | | 0.5 | | μC |
| I _{RM} | Peak Reverse Recovery Current | R _G =20Ω, V _{GE} =-15V | T _j =25°C | | 10 | | A |
| E _{rec} | Reverse Recovery Energy | | T _j =25°C | | 2.4 | | mJ |

Thermal Characteristics

| Symbol | Parameter | Typ. | Max. | Units |
|-------------------|--|-------|------|-------|
| R _{thJC} | Junction-to-Case (per IGBT) | | 0.38 | K/W |
| R _{thJC} | Junction-to-Case (per Diode) | | 0.58 | K/W |
| R _{thCS} | Case-to-Sink (per IGBT -Conductive grease applied) | 0.082 | | K/W |
| R _{thCS} | Case-to-Sink (per Diod-Conductive grease applied) | 0.13 | | K/W |

Package Dimensions

